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## **ABSTRACT**

A method of fabricating a semiconductor device including providing a semiconductor heterostructure, the heterostructure having a relaxed Si<sub>1-x</sub>Ge<sub>x</sub> layer on a substrate, a strained channel layer on the relaxed Si<sub>1-x</sub>Ge<sub>x</sub> layer, and a Si<sub>1-y</sub>Ge<sub>y</sub> layer; removing the Si<sub>1-y</sub>Ge<sub>y</sub> layer; and providing a dielectric layer. The dielectric layer includes a gate dielectric of a MISFET. In alternative embodiments, the heterostructure includes a SiGe spacer layer and a Si layer.

